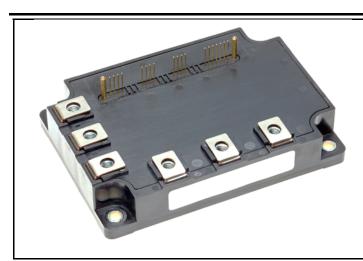


<Intelligent Power Modules>

# PM150RG1C120

FLAT-BASE TYPE INSULATED PACKAGE



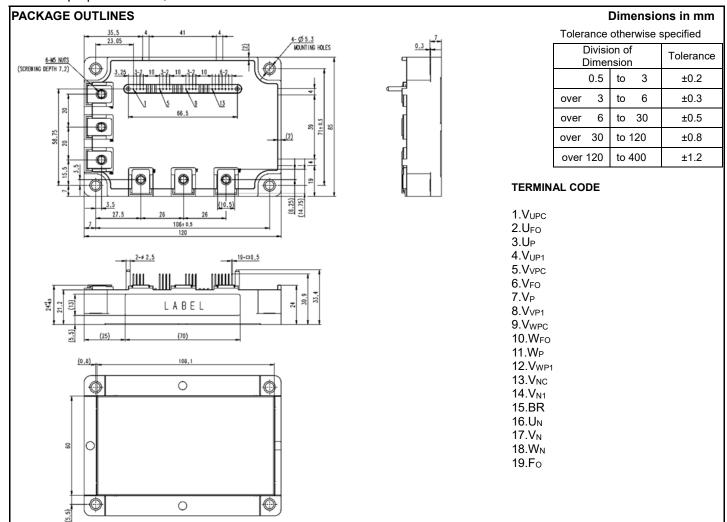
#### **FEATURE**

- a) Adopting Full-Gate CSTBT chip.
- b) The over-temperature protection which detects the chip surface temperature of CSTBT is adopted.
- c) Error output signal is available from each protection upper and lower arm of IPM.
- d) Outputting an error signal corresponding to the abnormal state (error mode identification)

This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU.

#### **APPLICATION**

General purpose inverter, servo drives and other motor controls



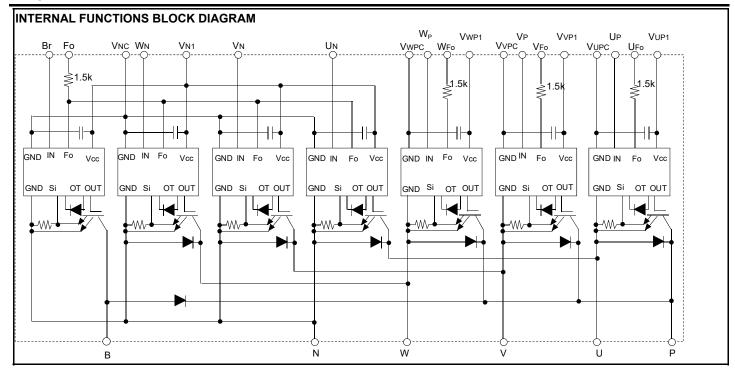
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Publication date: Nov, 2017

# PM150RG1C120

HIGH POWER SWITCHING USE

**INSULATED TYPE** 



#### **MAXIMUM RATINGS** (Tvj = 25°C, unless otherwise noted)

#### **INVERTER PART**

$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	IIIVERTER PART								
$\begin{array}{c} I_{C} \\ I_{CRM} \end{array} \begin{array}{c} T_{C} = 25 \ ^{\circ}C \\ \hline Pulse \end{array} \\ P_{tot} \hspace{0.5cm} Total \hspace{0.5cm} Power \hspace{0.5cm} Dissipation \hspace{0.5cm} T_{C} = 25 \ ^{\circ}C \\ \hline I_{E} \hspace{0.5cm} Emitter \hspace{0.5cm} Current \hspace{0.5cm} T_{C} = 25 \ ^{\circ}C \\ \hline I_{ERM} \hspace{0.5cm} (Free-wheeling \hspace{0.5cm} Diode \hspace{0.5cm} Forward \hspace{0.5cm} current) \end{array}$	Symbol	Parameter	Conditions	Ratings	Unit				
Collector Current Pulse  Ptot Total Power Dissipation T <sub>C</sub> =25 °C  I <sub>E</sub> Emitter Current T <sub>C</sub> =25 °C  I <sub>ERM</sub> (Free-wheeling Diode Forward current) Pulse	$V_{CES}$	Collector-Emitter Voltage	V <sub>D</sub> =15 V, V <sub>CIN</sub> =15 V	1200	V				
I <sub>CRM</sub> Pulse           P <sub>tot</sub> Total Power Dissipation         T <sub>C</sub> =25 °C           I <sub>E</sub> Emitter Current         T <sub>C</sub> =25 °C           I <sub>ERM</sub> (Free-wheeling Diode Forward current)         Pulse	Ic	Collector Current	T <sub>C</sub> =25 °C	150	^				
I <sub>E</sub> Emitter Current T <sub>C</sub> =25 °C   I <sub>ERM</sub> (Free-wheeling Diode Forward current) Pulse	I <sub>CRM</sub>	Collector Current	Pulse	300	Α				
I <sub>ERM</sub> (Free-wheeling Diode Forward current) Pulse	$P_{tot}$	Total Power Dissipation	T <sub>C</sub> =25 °C	961	W				
	I <sub>E</sub>	Emitter Current	T <sub>C</sub> =25 °C	150	^				
Tvi Junction Temperature -20	I <sub>ERM</sub>	(Free-wheeling Diode Forward current)	Pulse	300	Α				
	Tvj	Junction Temperature		-20 ~ +150	°C				

<sup>\*:</sup> Tc measurement point is just under the chip.

#### **BRAKE PART**

Symbol	Parameter	Conditions	Ratings	Unit
V <sub>CES</sub>	Collector-Emitter Voltage	V <sub>D</sub> =15 V, V <sub>CIN</sub> =15 V	1200	V
I <sub>C</sub>	Collector Current	T <sub>C</sub> =25 °C	75	
I <sub>CRM</sub>	Collector Current	Pulse	150	Α
P <sub>tot</sub>	Total Power Dissipation	T <sub>C</sub> =25 °C	595	W
$V_{R(DC)}$	Diode Rated Reverse DC Voltage	T <sub>C</sub> =25 °C	1200	V
I <sub>F</sub>	Diode Forward Current	T <sub>C</sub> =25 °C	75	Α
Tvj	Junction Temperature		-20 ~ +150	°C

 $<sup>\</sup>ensuremath{^{*:}}$  Tc measurement point is just under the chip.

### **CONTROL PART**

Symbol	Parameter	Conditions	Ratings	Unit
$V_D$	Supply Voltage	Applied between: V <sub>UP1</sub> -V <sub>UPC</sub> , V <sub>VP1</sub> -V <sub>VPC</sub> , V <sub>WP1</sub> -V <sub>WPC</sub> , V <sub>N1</sub> -V <sub>NC</sub>	20	V
$V_{CIN}$	Input Voltage	Applied between: $U_P$ - $V_{UPC}$ , $V_P$ - $V_{VPC}$ , $W_P$ - $V_{WPC}$ , $U_N$ , $V_N$ , $W_N$ , $Br$ - $V_{NC}$	20	V
$V_{FO}$	Fault Output Supply Voltage	Applied between: U <sub>FO</sub> -V <sub>UPC</sub> , V <sub>FO</sub> -V <sub>VPC</sub> , W <sub>FO</sub> -V <sub>WPC</sub> , Fo-V <sub>NC</sub>	20	V
I <sub>FO</sub>	Fault Output Current	Sink current at U <sub>FO</sub> , V <sub>FO</sub> , W <sub>FO</sub> , Fo terminals	20	mA

# PM150RG1C120

HIGH POWER SWITCHING USE INSULATED TYPE

#### **TOTAL SYSTEM**

Symbol	Parameter	Conditions	Ratings	Unit
V <sub>CC(PROT)</sub>	Supply Voltage Protected by SC	V <sub>D</sub> =13.5 V∼16.5 V, Inverter Part, Tvj=+125°C start	800	V
$T_{stg}$	Storage Temperature	-	-40 ~ +125	°C
Tc	Operating Case Temperature	-	-20 ~ +125	°C
V <sub>isol</sub>	Isolation Voltage	60Hz, Sinusoidal, Charged part to Base plate, AC 1min, RMS	2500	V

<sup>\*:</sup> Tc measurement point is just under the chip.

#### THERMAL RESISTANCE

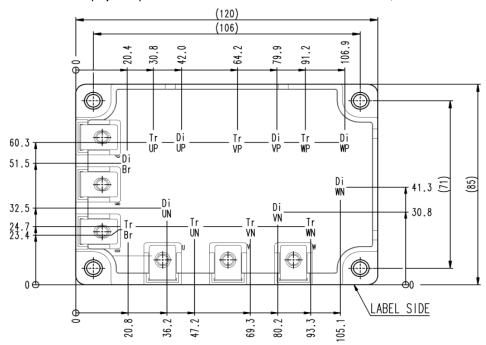
Symbol	Parameter	Conditions	Limits			Linit
		Conditions	Min.	Тур.	Max.	Unit
$R_{th(j-c)Q}$	Thermal Resistance	Inverter, Junction to case, IGBT, per 1 element (Note1)	-	-	0.13	
$R_{th(j-c)D}$		Inverter, Junction to case, FWD, per 1 element (Note1)	-	-	0.18	K/W
$R_{th(j-c)Q}$		Brake, Junction to case, IGBT, per 1 element (Note1)	-	-	0.21	
$R_{th(j-c)D}$		Brake, Junction to case, FWD, per 1 element (Note1)	-	-	0.30	
R <sub>th(c-s)</sub>	Contact Thermal Resistance	Case to heat sink, per 1 module,	-	8.4	_	K/kW
		Thermal grease applied (Note.1, 2)		5.1	•	IVIXV

Note1. If you use this value,  $R_{\text{th(s-a)}}\,\text{should}$  be measured just under the chips.

Note2. Typical value is measured by using thermally conductive grease of  $\lambda$ =0.9W/(m·K),  $D_{\text{(C-S)}}$ =50  $\mu$ m.

#### **CHIP LOCATION (Top view)**

Dimension in mm, torelance: ±1mm



Tr\*\* : IGBT Di\*\* : FWD

## <Intelligent Power Modules>

# PM150RG1C120

HIGH POWER SWITCHING USE

INSULATED TYPE

## **ELECTRICAL CHARACTERISTICS** (Tvj= 25°C, unless otherwise noted)

### **INVERTER PART**

Cymbol		Conditions			Limits		Unit	
Symbol	Parameter	Conditions			Min.	lin. Typ. Max.	Max.	Offic
		V -15 V I -150 A	Tv:=25 °C	Terminal	-	-	1.9	
V	Collector-Emitter Saturation Voltage	V <sub>D</sub> =15 V, I <sub>C</sub> =150 A	Tvj=25 °C	Chip	-	1.3	-	V
V <sub>CEsat</sub>	Collector-Emitter Saturation voltage	V <sub>CIN</sub> =0 V, Pulsed, (Fig.1)	Tvj=125 °C	Terminal	-	-	2.15	V
		V <sub>CIN</sub> -0 V, Fulsed, (Fig. I)	1 Vj = 125 C	Chip	-	1.5	1	
		V <sub>D</sub> =15 V, I <sub>E</sub> =150 A,	Tvj=25 °C	Terminal	-	-	2.4	V
V	Emitter-Collector Voltage			Chip	-	1.75	-	
V <sub>EC</sub> Emitter-Collector Volta	Emilier-Collector Voltage	V <sub>CIN</sub> = 15 V, pulsed, (Fig.2) Tvj=125 °C	Tvi=125 °C	Terminal	-	-	2.65	V
			1 Vj=125 C	Chip	-	1.95	ı	
t <sub>on</sub>		V <sub>D</sub> =15 V, V <sub>CIN</sub> =0 V←→15 V,		0.3	0.8	1.2		
t <sub>rr</sub>		V <sub>CC</sub> =600 V, I <sub>C</sub> =150A,		-	0.2	0.4		
t <sub>c(on)</sub>	Switching Time	Tvj=125 °C, Inductive Load		-	0.2	0.4	μs	
t <sub>off</sub>					-	1.2	2.8	
t <sub>c(off)</sub>		(Fig.3, 4)			-	0.4	1.2	
	Collector Emitter Cut off Current	\(\( -4\)\(\)\(\)\(\)\(\)\(\)		Tvj=25 °C	-	-	1	m 1
I <sub>CES</sub> Collecto	ollector-Emitter Cut-off Current			Tvj=125 °C	-	-	10	mA

#### **BRAKE PART**

Come he al	Parameter	Conditions		Limits			1.124	
Symbol	Parameter	Condition	is		Min.	Тур.	Max.	Unit
		V <sub>D</sub> =15 V, I <sub>C</sub> =150A	Tvj=25 °C	Terminal	-	-	1.8	
		VB-13 V, IC-130A	1 1 7 2 5 6	Chip	-	1.3	-	.,
V <sub>CEsat</sub>	Collector-Emitter Saturation Voltage	V <sub>CIN</sub> =0 V, Pulsed, (Fig.1)	Tvj=125 °C	Terminal	-	-	2.05	V
				Chip	-	1.5	-	
	5: 1.5	I <sub>F</sub> =150A Tvj=25 °C Tvj=125 °C	Tvj=25 °C	Terminal	-	-	2.4	V
\ /				Chip	-	1.75	-	
$V_{FM}$	Diode Forward Voltage		T : 405.00	Terminal	-	-	2.65	
			Chip	-	1.95	-		
	0.11	V <sub>CE</sub> =V <sub>CES</sub> , V <sub>D</sub> =15 V, V <sub>CIN</sub> =15 V (Fig.5)		Tvj=25 °C	-	-	1	4
I <sub>CES</sub>	Collector-Emitter Cut-off Current			Tvj=125 °C	-	-	10	mA

### <Intelligent Power Modules>

# PM150RG1C120

HIGH POWER SWITCHING USE

INSULATED TYPE

#### **ELECTRICAL CHARACTERISTICS** (Tvj = 25°C, unless otherwise noted)

#### **CONTROL PART**

Symbol	Parameter	Conditions	Conditions		Limits			
Symbol	1 arameter Conditions			Min.	Тур.	Max.	Unit	
		V =45 V V =45 V	V <sub>P1</sub> -V <sub>PC</sub>	-	4	6		
	Circuit Comment	V <sub>D</sub> =15 V, V <sub>CIN</sub> =15 V	V <sub>N1</sub> -V <sub>NC</sub>	-	16	24		
I <sub>D</sub>	Circuit Current	V <sub>D</sub> =15 V, V <sub>CIN</sub> =0 V←15 V, V <sub>CC</sub> =800 V	V <sub>P1</sub> -V <sub>PC</sub>	-	42	50	mA	
		I <sub>C</sub> =0A, Tvj=125 °C, f <sub>C</sub> ≤20kHz	V <sub>N1</sub> -V <sub>NC</sub>	-	148	173		
$V_{th(ON)}$	Input ON Threshold Voltage	Applied between:		1.2	1.5	1.8	V	
$V_{th(OFF)}$	Input OFF Threshold Voltage	$U_{P}$ - $V_{UPC}$ , $V_{P}$ - $V_{VPC}$ , $W_{P}$ - $V_{WPC}$ , $U_{N}$ , $V_{N}$ , $W_{N}$ ,	Br-V <sub>NC</sub>	1.7	2.0	2.3	V	
00	Short Circuit Trip Level	-20≤Tvj≤125 °C, V <sub>D</sub> =15 V (Fig.3, 6)	Inverter	300	-	-	_	
SC			Brake	150	-	-	Α	
t <sub>d(SC)</sub>	Short Circuit Current Delay Time	V <sub>D</sub> =15 V, Tvj=125 °C (Fig.3, 6)		-	2.0	-	μs	
ОТ	Over Terror eneture Bretestier	Detect to we seek we of ICDT this surface.	Trip level	150	-	-	°C	
OT <sub>(hys)</sub>	Over Temperature Protection	Detect temperature of IGBT chip surface	Hysteresis	-	20	-		
UV <sub>t</sub>	Supply Circuit		Trip level	11.0	12.0	12.7	V	
UV <sub>r</sub>	Under-Voltage Protection	-	Reset level	-	12.5	-	V	
I <sub>FO(H)</sub>	Facility Control of Control	V 45 V V 45 V (Note 0)	•	-	-	0.01	4	
I <sub>FO(L)</sub>	Fault Output Current	V <sub>D</sub> =15 V, V <sub>FO</sub> =15 V (Note3)		-	10	15	mA	
			ОТ	-	8.0	-		
t <sub>FO</sub>	Fault Output Pulse Width	V <sub>D</sub> =15 V (Note3)	UV	-	4.0	-	ms	
			SC	-	2.0	-		

Note3. Fault output is given only when the internal SC, OT & UV protections schemes of either upper or lower arm device operate to protect it.

#### **MECHANICAL RATINGS AND CHARACTERISTICS**

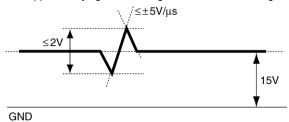
Symbol	Parameter	Conditions		Unit		
		Conditions		Тур.	Max.	Unit
Ms	Mounting Torque	Mounting part screw : M5	2.5	3.0	3.5	N•m
$M_t$	Mounting Torque	Main terminal part screw : M5	2.5	3.0	3.5	INTIII
m	mass	-	-	425	-	g

#### **RECOMMENDED CONDITIONS FOR USE**

Symbol	Parameter	Conditions	Recommended value	Unit
V <sub>CC</sub>	Supply Voltage	Applied across P-N terminals	≤ 800	V
$V_D$	Control Supply Voltage	Applied between:  V <sub>UP1</sub> -V <sub>UPC</sub> , V <sub>VP1</sub> -V <sub>VPC</sub> , V <sub>WP1</sub> -V <sub>WPC</sub> ,V <sub>N1</sub> -V <sub>NC</sub> (Note4)	15.0±1.5	V
V <sub>CIN(ON)</sub>	Input ON Voltage	Applied between :	≤ 0.8	V
$V_{CIN(OFF)}$	Input OFF Voltage	$U_P$ - $V_{UPC}$ , $V_P$ - $V_{VPC}$ , $W_P$ - $V_{WPC}$ , $U_N$ , $V_N$ , $W_N$ , $Br$ - $V_{NC}$	≥ 9.0	V
f <sub>PWM</sub>	PWM Input Frequency	Using Application Circuit of Fig. 8	≤ 20	kHz
t <sub>dead</sub>	Arm Shoot-through Blocking Time	For IPM's each input signals (Fig.7)	≥ 2.5	μs

This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU.

Note4. With ripple satisfying the following conditions: dv/dt swing ≤ ±5 V/µs, Variation ≤ 2 V peak to peak



#### PRECAUTIONS FOR TESTING

- 1. Before applying any control supply voltage (V<sub>D</sub>), the input terminals should be pulled up by resistors, etc. to their corresponding supply voltage and each input signal should be kept off state.
  - After this, the specified ON and OFF level setting for each input signal should be done.
- 2. When performing "SC" tests, the turn-off surge voltage spike at the corresponding protection operation should not be allowed to rise above V<sub>CES</sub> rating of the device.

(These test should not be done by using a curve tracer or its equivalent.)

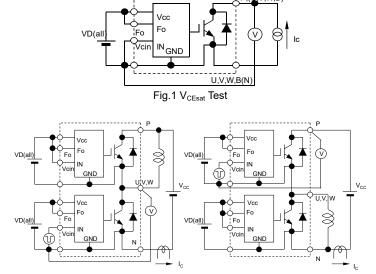
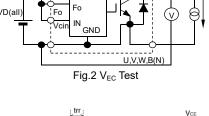


Fig.3 Switching time and SC test circuit



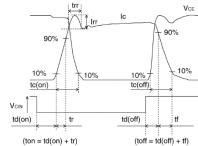


Fig.4 Switching time test waveform

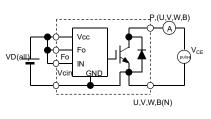


Fig.5 I<sub>CES</sub> Test

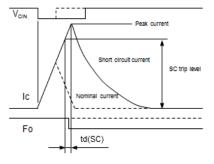
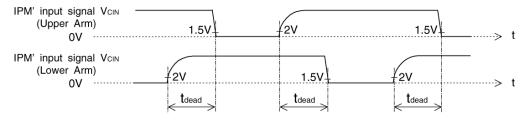


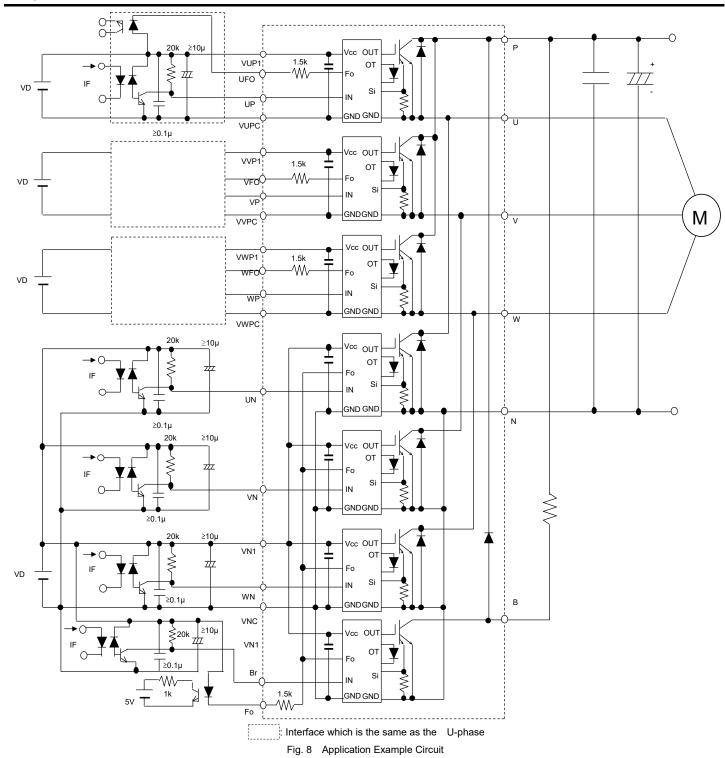
Fig.6 SC test waveform



1.5V: Input on threshold voltage Vth(on) typical value, 2V: Input off threshold voltage Vth(off) typical value

Fig. 7 Dead time measurement point example

**INSULATED TYPE** 

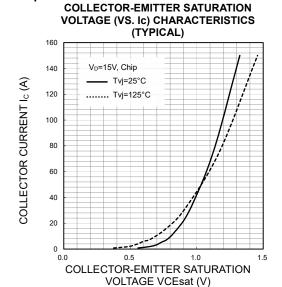


#### NOTES FOR STABLE AND SAFE OPERATION;

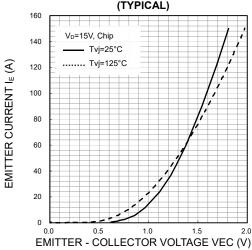
- Design the PCB pattern to minimize wiring length between opto-coupler and IPM's input terminal, and also to minimize the stray capacity between the input and output wirings of opto-coupler.
- · Connect low impedance capacitor between the Vcc and GND terminal of each fast switching opto-coupler.
- Fast switching opto-couplers:  $t_{PLH}$ ,  $t_{PHL} \le 0.8 \mu s$ , Use High CMR type.
- Slow switching opto-coupler: CTR > 100% (\*can be applied to Brake part input signal, in this case, resistor should be selected properly).
- Use 4 isolated control power supplies (V<sub>D</sub>). Also, care should be taken to minimize the instantaneous voltage charge of the power supply.
- Make inductance of DC bus line as small as possible, and minimize surge voltage using snubber capacitor between P and N terminal.

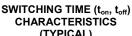
# INSULATED TYPE

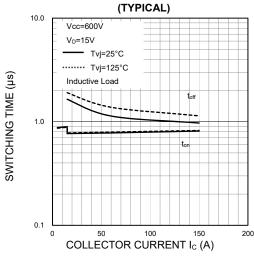
# PERFORMANCE CURVES Inverter part



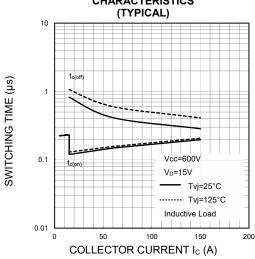
#### FREE WHEELING DIODE FORWARD CHARACTERISTICS (TYPICAL)



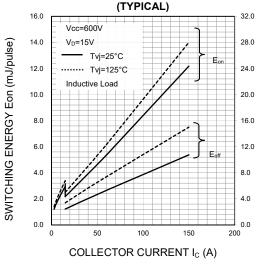




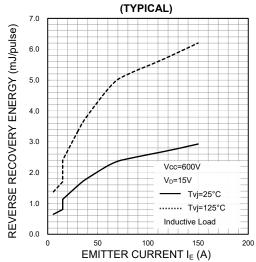
SWITCHING TIME (t<sub>c(on)</sub>, t<sub>c(off)</sub>) CHARACTERISTICS



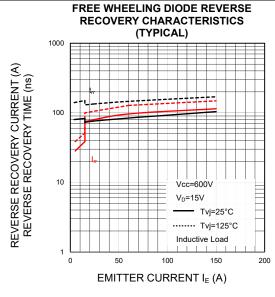
# SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

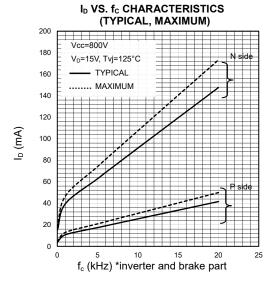


# FREE WHEELING DIODE REVERSE RECOVERY ENERGY CHARACTERISTICS

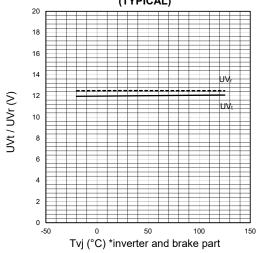


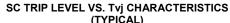
SWITCHING ENERGY Eoff (mJ)

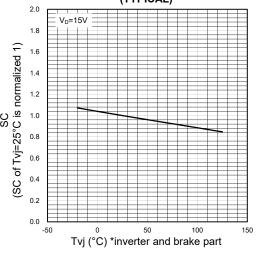




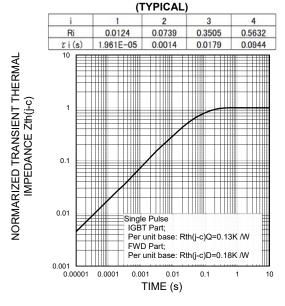








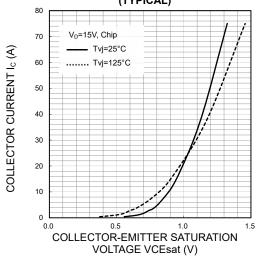
# TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



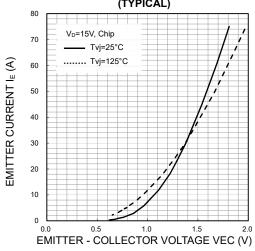
#### **INSULATED TYPE**

# PERFORMANCE CURVES Brake part

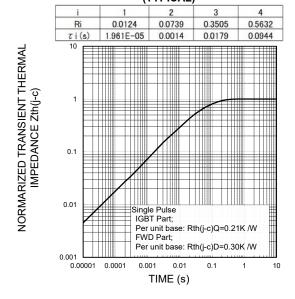
#### COLLECTOR-EMITTER SATURATION VOLTAGE (VS. Ic) CHARACTERISTICS (TYPICAL)



#### FREE WHEELING DIODE FORWARD CHARACTERISTICS (TYPICAL)



#### TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (TYPICAL)



## PM150RG1C120

HIGH POWER SWITCHING USE INSULATED TYPE

#### Keep safety first in your circuit designs!

This product is designed for industrial application purpose. The performance, the quality and support level of the product is guaranteed by "Customer's Std. Spec.".

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